

STGWA60NC60WDR

60 A, 600 V, ultrafast IGBT

Features

- Very high frequency operation
- Low C_{RES} / C_{IES} ratio (no cross-conduction susceptibility)
- Very soft ultrafast recovery antiparallel diode

Applications

- Welding
- Power factor correction
- SMPS
- High frequency inverter/converter

Description

This device is an ultrafast IGBT. It utilizes the advanced Power MESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

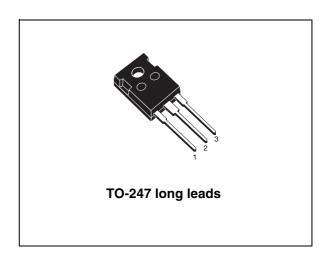


Figure 1. Internal schematic diagram

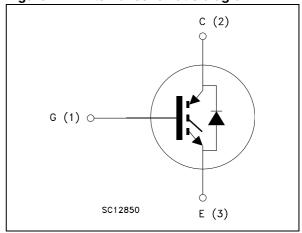


Table 1. Device summary

Order code	Marking	Package	Packaging
STGWA60NC60WDR	GWA60NC60WDR	TO-247 long leads	Tube

Electrical ratings STGWA60NC60WDR

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C ⁽¹⁾	Collector current (continuous) at T _C = 25 °C	130	Α
I _C ⁽¹⁾	Collector current (continuous) at T _C = 100 °C	60	Α
I _{CL} (2)	Turn-off latching current	250	Α
I _{CP} (3)	Pulsed collector current	250	Α
IF	Diode RMS forward current at T _C = 25 °C	30	Α
I _{FSM}	Surge not repetitive forward current (t _p = 10 ms sinusoidal)	120	А
V _{GE}	Gate-emitter voltage	± 20	V
P _{TOT}	Total dissipation at T _C = 25 °C	340	W
T _j	Operating junction temperature	- 55 to 150	°C

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX}^{-T}C}{R_{THJ-C}^{\times V}CESAT(MAX)^{(T}C, ^{I}C)}$$

- 2. V_{clamp} = 480 V, T_J = 150 °C, R_G = 10 Ω , V_{GE} = 15 V
- 3. Pulse width limited by max. temperature allowed

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case IGBT max.	0.35	°C/W
R _{thj-case}	Thermal resistance junction-case diode max.	1.25	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max.	50	°C/W

2 Electrical characteristics

 $T_{CASE} = 25 \, ^{\circ}C$ unless otherwise specified

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			V
V _{CE(sat)}	Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, I_{C} = 40 \text{ A}$ $V_{GE} = 15 \text{ V}, I_{C} = 40 \text{ A}, T_{C} = 125 ^{\circ}\text{C}$		2.1 1.9	2.6	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	3.75		5.75	V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} = 600 V V _{CE} = 600 V,T _C = 125 °C			500 5	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ± 20 V			±100	nA
9fs	Forward transconductance	$V_{CE} = 15 V_{,} I_{C} = 40 A$		25		S

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0		4700 410 90		pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 390 \text{ V}, I_{C} = 40 \text{ A},$ $V_{GE} = 15 \text{ V},$ <i>Figure 16</i>		195 32 82		nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390 V, I_{C} = 40 A R_{G} = 10 Ω , V_{GE} = 15 V, Figure 17, Figure 15		40 30 1039		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V, } I_{C} = 40 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V,}$ $T_{C} = 125 \text{ °C}$ Figure 17, Figure 15		37 32 990		ns ns A/µs
t _{r(Voff)} t _{d(Voff)} t _f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 390 V, I_{C} = 40 A R_{G} = 10 Ω , V_{GE} = 15 V, Figure 17, Figure 15		31 240 35		ns ns ns
t _{r(Voff)} t _{d(Voff)} t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V, } I_{C} = 40 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V,}$ $T_{C} = 125 ^{\circ}\text{C}$ Figure 17, Figure 15		59 280 63		ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390 \text{ V}, I_{C} = 40 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ Figure 15		743 560 925		μJ μJ μJ
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390 \text{ V}, I_{C} = 40 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{C} = 125 \text{ °C}$ Figure 15		917 910 1545		μJ μJ μJ

Eon is the tun-on losses when a typical diode is used in the test circuit in *Figure 18* If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C)

Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _F	Forward on-voltage	I _F = 40 A I _F = 40 A, T _C = 125 °C		3.2 2.2		V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 40 \text{ A}, V_R = 50 \text{ V},$ di/dt = 100 A/ μ s Figure 18		42 55 2.6		ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 40 \text{ A}, V_R = 50 \text{ V},$ $T_C = 125 ^{\circ}\text{C},$ $di/dt = 100 \text{A/µs} (Figure 18)$		141 324 4.6		ns nC A

^{2.} Turn-off losses include also the tail of the collector current

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

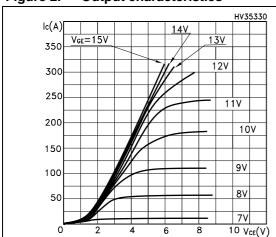


Figure 3. Transfer characteristics

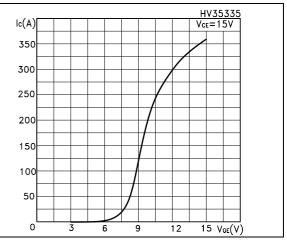
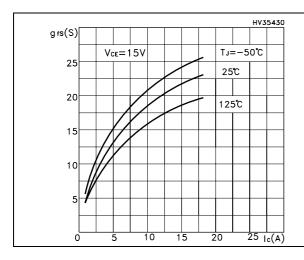


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs. temperature



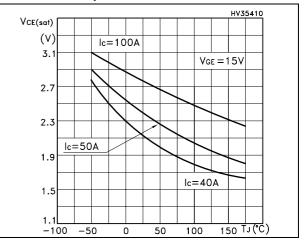
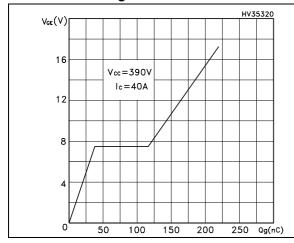
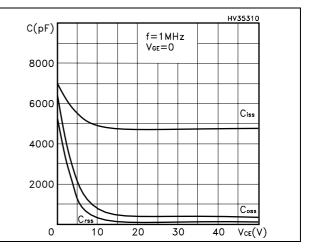


Figure 6. Gate charge vs. gate-source voltage

Figure 7. Capacitance variations





Electrical characteristics STGWA60NC60WDR

Figure 8. Normalized gate threshold voltage Figure 9. Collector-emitter on voltage vs. vs. temperature collector current

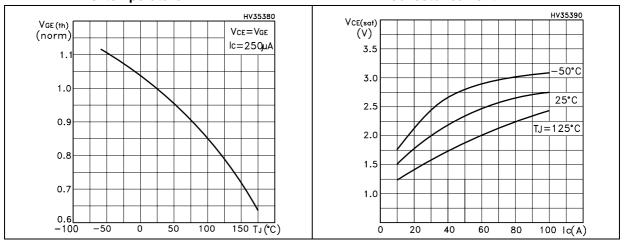


Figure 10. Normalized breakdown voltage vs. Figure 11. Switching losses vs. I_C temperature

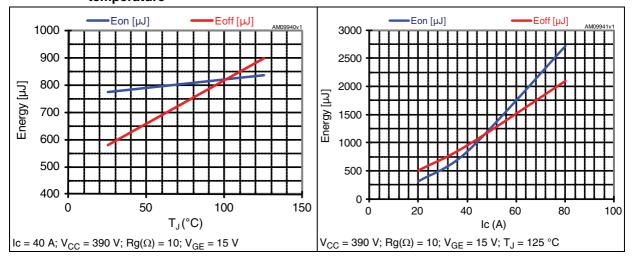
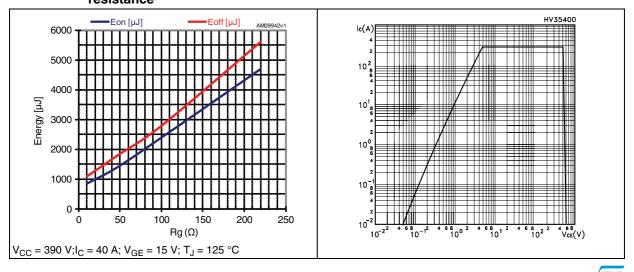


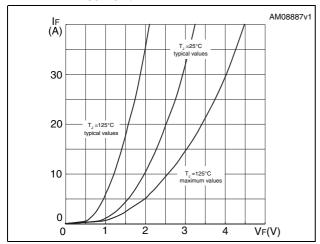
Figure 12. Switching losses vs. gate resistance

Figure 13. Turn-off SOA



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Figure 14. Forward voltage drop vs. forward current



Test circuit STGWA60NC60WDR

3 Test circuit

Figure 15. Test circuit for inductive load switching

Figure 16. Gate charge test circuit

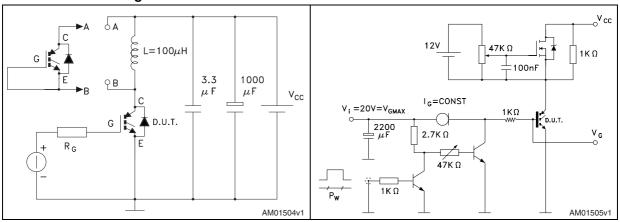
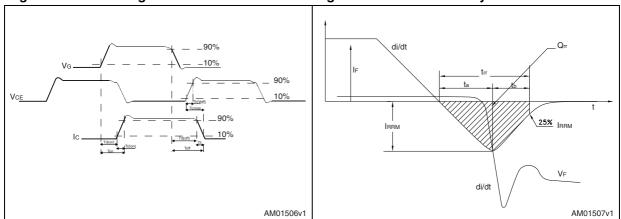


Figure 17. Switching waveform

Figure 18. Diode recovery time waveform



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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 9. TO-247 long leads mechanical data

	247 long leads meone	mm	
Dim.	Min.	Тур.	Max.
А	4.90		5.15
D	1.85		2.10
E	0.55		0.67
F	1.07		1.32
F1	1.90		2.38
F2	2.87		3.38
G		10.90 BSC	
Н	15.77		16.02
L	20.82		21.07
L1	4.16		4.47
L2	5.49		5.74
L3	20.05		20.30
L4	3.68		3.93
L5	6.04		6.29
М	2.27		2.52
V		10°	
V1		3°	
V3		20°	
Dia.	3.55		3.66

HEAT-SINK PLANE

LA

DIA

BACK VIEW

7395426_E

Figure 19. TO-247 long leads drawing

STGWA60NC60WDR Revision history

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
20-Jul-2011	1	Initial release.

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